

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TAKA AKI MAEDA	01/27/2022
SUGIHIDE NAKASHIMA	01/27/2022
RECEIVING PARTY DATA	
Name:	TOKYO SEIMITSU HATSUJO CO.,LTD.
Street Address:	134 HIGASHI KATA-CHO, TSUZUKI-KU
City:	YOKOHAMA-SHI KANAGAWA
State/Country:	JAPAN
Postal Code:	2240045
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17597971
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NAME OF SUBMITTER:	JOHN G. TUTUNJIAN
SIGNATURE:	/John G. Tutunjian/
DATE SIGNED:	01/31/2022
Total Attachments: 2	
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ASSIGNMENT

In consideration of Ten Dollars (\$10.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned, Takaaki Maeda and Sugihide Nakashima (hereinafter referred to as "Assignor(s)");

Hereby sell, assign and transfer to TOKYO SEIMITSU HATSUJO CO, LTD. (hereinafter referred to as "Assignee"), a corporation of Japan, having a place of business at 134 Higashikata-cho, Tsuzuki-ku, Yokohama-shi Kanagawa, Japan, 2240045 its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled:

SPIRAL CONVEYOR

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and received Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and said improvements; execute all rightful oaths, assignments, powers of attorney and other papers, communicate to said Assignee, its successors, assigns and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible

which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 01/27/2022
Month/Day/Year

Takaaki Maeda
Takaaki Maeda

Date: 01/27/2022
Month/Day/Year

Sugihide Nakashima
Sugihide Nakashima